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- Three-State Outputs Interface Directly with System Bus
- 'LS257B and 'LS258B Offer Three Times the Sink-Current Capability of the Original 'LS257 and 'LS258
- Same Pin Assignments as SN54LS157, SN74LS157, SN54S157, SN74S157, and SN54LS158, SN74LS158, SN54S158, SN74S158
- Provides Bus Interface from Multiple Sources in High-Performance Systems

| | AVERAGE PROPAGATION | TYPICAL |
|---------|---------------------|--------------|
| | DELAY FROM | POWER . |
| | DATA INPUT | DISSIPATIONT |
| 'LS257B | 9 ns | 55 mW |
| 'LS258B | 9 ns | 55 mW |
| 'S257 | 4.8 ns | 320 mW |
| 'S258 | 4 ns | 280 mW |

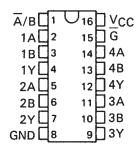
[†]Off state (worst case)

description

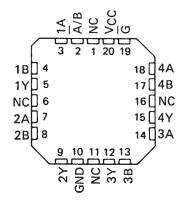
These devices are designed to multiplex signals from four-bit data sources to four-output data lines in busorganized systems. The 3-state outputs will not load the data lines when the output control pin (\overline{G}) is at a high-logic level.

Series 54LS and 54S are characterized for operation over the full military temperature range of -55° C to 125°C; Series 74LS and 74S are characterized for operation from 0°C to 70°C.

SN54LS257B, SN54S257, SN54LS258B, SN54S258 . . . J OR W PACKAGE SN74LS257B, SN74S257, SN74LS258B, SN74S258 . . . D OR N PACKAGE (TOP VIEW)



SN54LS257B, SN54S257, SN54LS258B, SN54S258 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection.

FUNCTION TABLE

| | INPUTS | | | OUTPUT Y | | | | |
|-------------------|--------|---|---|------------------|------------------|--|--|--|
| OUTPUT CONTROL | SELECT | А | В | 'LS257B 'S257 | 'LS258B 'S258 | | | |
| Н | Х | Х | Х | Z | Z | | | |
| L | L, | L | Х | L | Н | | | |
| L. | L | Н | Х | Н | L | | | |
| L | Н | Х | L | L | Н | | | |
| L | Н | Х | Н | Н | L | | | |

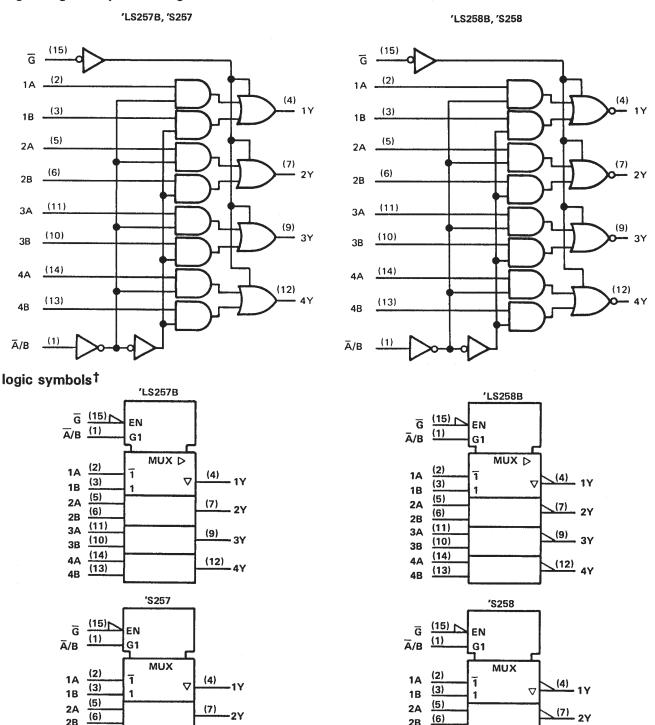
H = high level, L = low level, X = irrelevant,

Z = high Impedance (off)



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logic diagrams (positive logic)



(9)

(12)



2B

3A

3B

4A

(11)

(10)

(14)

(13)4B

2B

3A

3В

4A

(11)

(10)

(14)

(13)

(9) 3Y

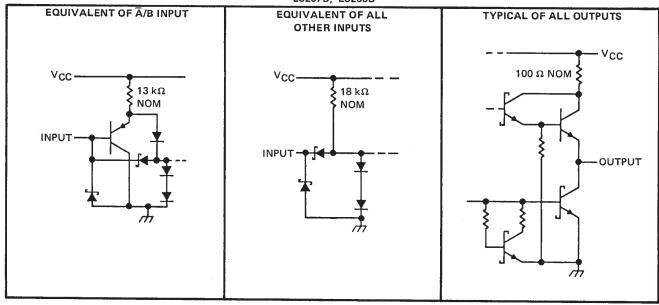
(12) 4Y

[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

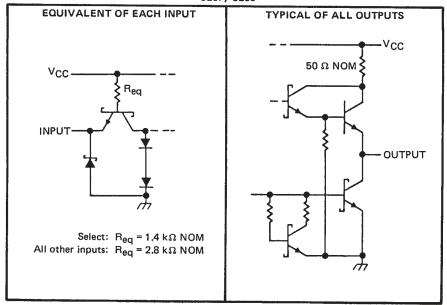
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schematics of inputs and outputs

'LS257B, 'LS258B



'S257, 'S258



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) | 7 V |
|--|---------------|
| Input voltage: 'LS257B, 'LS258B Circuits | 7 V |
| 'S257, 'S258 Circuits | 5.5 V |
| Off-state output voltage | 5.5 V |
| Operating free-air temperature range: SN54LS', SN54S' Circuits | 55°C to 125°C |
| SN74LS', SN74S' Circuits | |
| Storage temperature range | |

NOTE 1: Voltage values are with respect to network ground terminal.



SN54LS257B, SN54LS258B, SN54S257, SN54S258 SN74LS257B, SN74LS258B, SN74S257, SN74S258 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

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recommended operating conditions

| | | | SN54LS | 3′ | | UNIT | | |
|----------|--------------------------------|------|--------|------------|------|------|-------------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNII |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V_{IH} | High-level input voltage | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| loh | High-level output current | | · | – 1 | | | - 2.6 | mΑ |
| loL | Low-level output current | | | 12 | | | 24 | mA |
| TA | Operating free-air temperature | - 55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | | | | | | SN54LS | ., | T | | | |
|-------|------------------|---|------------------------|-------------------------|--------|---|-------|--------|--------|-------|------|
| ' | PARAMETER | TE | ST CONDITION | 1S [†] | MIN | TYP‡ | | MIN | SN74LS | MAX | UNIT |
| VIK | | V _{CC} = MIN, | 1 ₁ = 18 mA | | IVIIIV | LIFT | - 1.5 | IVIIIV | ITP+ | - 1.5 | V |
| Vон | | V _{CC} = MIN, I _{OH} = MAX | V _{IH} = 2 V, | V _{IL} = MAX, | 2.4 | 3.4 | | 2.4 | 3.1 | | V |
| VOL | | VCC = MIN, | V _{IH} = 2 V, | I _{OL} = 12 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| - OL | | VIL = MAX, | | I _{OL} = 24 mA | | *************************************** | | | 0.35 | 0.5 | ٧ |
| lozh | | | V _{IH} = 2 V, | | | | 20 | | | 20 | μΑ |
| lozL | | V _{CC} -MAX, | $V_{1H} = 2 V$ | V _O = 0.4 V | | | 20 | | | - 20 | μΑ |
| 11 | | V _{CC} = MAX, | V1 = 7 V | | | | 0.1 | | | 0.1 | mA |
| ЧН | | V _{CC} = MAX, | V1 = 2.7 V | | | | 20 | | | 20 | μΑ |
| յլլ | | V _{CC} = MAX, | V _I = 0.4 V | | | | - 0.4 | | | - 0.4 | mA |
| los § | | V _{CC} = MAX, | | | - 30 | | - 130 | 30 | | - 130 | mA |
| | All outputs high | | | | | 8 | 12 | | 8 | 12 | |
| | All outputs low | | | 'LS257B | | 12 | 18 | | 12 | 18 | 1 |
| loo | All outputs off | V | Con Note 0 | | | 13 | 19 | | 13 | 19 | 1 |
| Icc | All outputs high | V _{CC} = MAX, | See Note 2 | | | 6 | 9 | | 6 | 9 | mA |
| | All outputs low | | | 'LS258B | | 10 | 15 | | 10 | 15 | 7 |
| | All outputs off | | | | | 11 | 16 | | 11 | 16 | 1 |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}C$.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$. $R_{I} = 667 \Omega$

| PARAMETER | FROM | то | TEST CONDITIONS | | | 'LS257 | В | | 'LS258 | В | | | | | | | |
|------------------|---------|----------|-------------------------|------------|-----|---------------------|------------|-----|--------|-----|------|----|----|----|----|----|--|
| TATION ETER | (INPUT) | (OUTPUT) | 1231 001 | | | | MAX | MIN | TYP | MAX | UNIT | | | | | | |
| ^t PLH | Data | Any | | | | 8 | 13 | | 7 | 12 | | | | | | | |
| tPHL | Data | City | | | | 10 | 15 | | 11 | 17 | ns | | | | | | |
| ^t PLH | Select | Anv | C _L = 45 pF, | See Note 3 | | 16 | 21 | | 14 | 21 | | | | | | | |
| tPHL | | Any | Ally | | 7, | ο <u>ς</u> - 45 με, | See Note S | | 17 | 24 | | 19 | 24 | ns | | | |
| ^t PZH | Output | Λ | Anv | Anv | Anv | Anv | Any | Anv | | | | 15 | 30 | | 15 | 30 | |
| ^t PZL | Control | City | | | | 19 | 30 | | 20 | 30 | ns | | | | | | |
| ^t PHZ | Output | Any | C. = 5 nE | Son Note 2 | | 18 | 30 | | 18 | 30 | | | | | | | |
| ^t PLZ | Control | | C _L = 5 pF, | See Note 3 | | 16 | 25 | | 16 | 25 | ns | | | | | | |

¶tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level



[§]Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured with all outputs open and all possible inputs grounded while achieving the stated output conditions.

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recommended operating conditions

| | | SN54S' | | | UNIT | | |
|------------------------------------|-----|--------|-----|------|------|------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX | CIVIT |
| Supply voltage, V _{CC} | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | ٧ |
| High-level output current, IOH | | | -2 | | | 6.5 | mΑ |
| Low-level output current, IOL | | | 20 | | | 20 | mA |
| Operating free-air temperature, TA | 55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | | | | | L | | 'S257 | | | 'S258 | | UNIT |
|----------------|------------------------------|------------------|--|---|--------|-----|--------------|------|------------|------------------|------|------|
| | PARAME | TER | TEST | CONDITIONS ¹ | F | MIN | TYP‡ | MAX | MIN | TYP [‡] | MAX | UNIT |
| VIH | High-level input | voltage | | | | 2 | | | 2 | | | V |
| VIL | Low-level input | | | | | | | 0.8 | | | 0.8 | ٧ |
| VIK | Input clamp vol | | V _{CC} = MIN, | I _I = -18 mA | | | | -1.2 | | | -1.2 | V |
| | | | V _{CC} = MIN, V _{IL} = 0.8 V, | V _{IH} = 2 V, I _{OH} = -1 mA | SN745' | 2.7 | | | 2.7 | | | v |
| VOH | OH High-level output voltage | | V _{CC} = MIN, | V _{IH} = 2 V, | SN54S' | 2.4 | 3.4 | | 2.4 | 3.4 | | , |
| | | | V _{IL} = 0.8 V, | IOH = MAX | SN74S' | 2.4 | 3.2 | | 2.4 | 3.2 | | |
| VOL | Low-level outpu | ut voltage | V _{CC} = MIN, V _{IL} = 0.8 V, | V _{1H} = 2 V, I _{OL} = 20 mA | | | | 0.5 | | | 0.5 | ٧ |
| lozh | Off-state output | | V _{CC} = MAX, V _O = 2.4 V | V _{IH} = 2 V, | | | | 50 | | | 50 | μА |
| lozL | Off-state output | * | V _{CC} = MAX, V _O = 0.5 V | V _{IH} = 2 V, | | | | -50 | | | -50 | μА |
| l ₁ | Input current a | t maximum | V _{CC} = MAX | , V _I = 5.5 V | | | | 1 | | | 1 | mA |
| | High-level | S input | | ., 07., | | | | 100 | | | 100 | μΑ |
| Ιн | input current | Any other | VCC = MAX | , V ₁ = 2.7 V | | | | 50 | | | 50 |] |
| | Low-level | S input | | V - 0.5.V | | | | -4 | | | -4 | mA |
| IIL. | input current | Any other | V _{CC} = MAX | V I = 0.5 V | | | | -2 | | | -2 | |
| los | Short-circuit ou | tput current§ | V _{CC} = MAX | | | -40 | | -100 | -40 | | -100 | mA |
| | | All outputs high | | | | | 44 | 68 | | 36 | 56 | 1 |
| ICC | | | | | | 60 | 93 | ļ | 52 | 81 | | |
| | | All outputs off |] | | | | 64 | 99 | | 56 | 87 | |

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_{A} = 25^{\circ}\text{C}$.

NOTE 2: ICC is measured with all outputs open and all possible inputs grounded while achieving the stated output conditions.

switching characteristics, V_{CC} = 5 V, T_A = 25°C, R_L = 280 Ω

| | FROM | то | TEST | | 'S257 | | | 'S258 | | UNIT |
|------------|---------|----------|------------------|-----|-------|------|-----|-------|------|-------|
| PARAMETER¶ | (INPUT) | (OUTPUT) | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| tPLH | 5-1- | A === | | | 5 | 7.5 | | 4 | 6 | ns |
| tPHL | Data | Any | | | 4.5 | 6.5 | | 4 | 6 |] ''' |
| tPLH | | | $C_L = 15 pF$, | | 8.5 | 15 | | 8 | 12 | ns |
| tPHL | Select | Any | See Note 3 | | 8.5 | 15 | | 7.5 | 12 | 113 |
| tPZH | Output | _ | 1 | | 13 | 19.5 | | 13 | 19.5 | ns |
| tPZL | Control | Any | | | 14 | 21 | | 14 | 21 | 1 " |
| tPHZ | Output | 1 | $C_L = 5 pF$, | | 5.5 | 8.5 | | 5.5 | 8.5 | |
| tPLZ | Control | Any | See Note 3 | | 9 | 14 | | 9 | 14 | ns |

¶f_{max} = Maximum clock frequency

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

tpZH = output enable time to high level

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

 $t_{PZL} \equiv$ output enable time to low level $t_{PHZ} \equiv$ output disable time from high level $t_{PLZ} \equiv$ output disable time from low level



Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.





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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-----------------------------|---------|
| 7603701EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701EA SNJ54LS257BJ | Samples |
| 7603701FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701FA SNJ54LS257BW | Samples |
| 7603701FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701FA SNJ54LS257BW | Samples |
| 7603801EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603801EA SNJ54LS258BJ | Samples |
| 7603801EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603801EA SNJ54LS258BJ | Samples |
| 8002301EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301EA SNJ54S258J | Samples |
| 8002301EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301EA SNJ54S258J | Samples |
| 8002301FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301FA SNJ54S258W | Samples |
| 8002301FA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301FA SNJ54S258W | Samples |
| JM38510/07906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BEA | Samples |
| JM38510/07906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BEA | Samples |
| JM38510/07906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BFA | Samples |
| JM38510/07906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BFA | Samples |
| JM38510/30906B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906B2A | Samples |
| JM38510/30906B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906B2A | Samples |
| JM38510/30906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BEA | Samples |





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| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| JM38510/30906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BEA | Samples |
| JM38510/30906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BFA | Samples |
| JM38510/30906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BFA | Samples |
| M38510/07906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BEA | Samples |
| M38510/07906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BEA | Samples |
| M38510/07906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BFA | Samples |
| M38510/07906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 07906BFA | Samples |
| M38510/30906B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906B2A | Samples |
| M38510/30906B2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906B2A | Samples |
| M38510/30906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BEA | Samples |
| M38510/30906BEA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BEA | Samples |
| M38510/30906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BFA | Samples |
| M38510/30906BFA | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 30906BFA | Samples |
| SN54LS257BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS257BJ | Samples |
| SN54LS257BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS257BJ | Samples |
| SN54LS258BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS258BJ | Samples |
| SN54LS258BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS258BJ | Samples |





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| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| SN54S257J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54S257J | Samples |
| SN54S257J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54S257J | Samples |
| SN74LS257BD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS257B | Samples |
| SN74LS257BD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS257B | Samples |
| SN74LS257BDR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS257B | Samples |
| SN74LS257BDR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS257B | Samples |
| SN74LS257BN | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS257BN | Samples |
| SN74LS257BN | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS257BN | Samples |
| SN74LS257BNSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS257B | Samples |
| SN74LS257BNSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS257B | Samples |
| SN74LS258BD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS258B | Samples |
| SN74LS258BD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS258B | Samples |
| SN74LS258BDR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS258B | Samples |
| SN74LS258BDR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS258B | Samples |
| SN74LS258BN | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS258BN | Samples |
| SN74LS258BN | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS258BN | Samples |
| SN74S257N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74S257N | Samples |
| SN74S257N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74S257N | Samples |
| SNJ54LS257BFK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS 257BFK | Samples |
| SNJ54LS257BFK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54LS 257BFK | Samples |





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| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|--------------------|--------------|---------------------------|---------|
| SNJ54LS257BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701EA SNJ54LS257BJ | Samples |
| SNJ54LS257BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701EA SNJ54LS257BJ | Samples |
| SNJ54LS257BW | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701FA SNJ54LS257BW | Samples |
| SNJ54LS257BW | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603701FA SNJ54LS257BW | Samples |
| SNJ54LS258BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603801EA SNJ54LS258BJ | Samples |
| SNJ54LS258BJ | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 7603801EA SNJ54LS258BJ | Samples |
| SNJ54S257J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54S257J | Samples |
| SNJ54S257J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54S257J | Samples |
| SNJ54S257W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54S257W | Samples |
| SNJ54S257W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ54S257W | Samples |
| SNJ54S258J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301EA SNJ54S258J | Samples |
| SNJ54S258J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301EA SNJ54S258J | Samples |
| SNJ54S258W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301FA SNJ54S258W | Samples |
| SNJ54S258W | ACTIVE | CFP | W | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 8002301FA SNJ54S258W | Samples |

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

PACKAGE OPTION ADDENDUM

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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS257B, SN54LS258B, SN54S257, SN74LS257B, SN74LS258B, SN74S257:

Catalog: SN74LS257B, SN74LS258B, SN74S257

Military: SN54LS257B, SN54LS258B, SN54S257

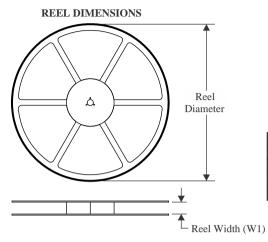
NOTE: Qualified Version Definitions:

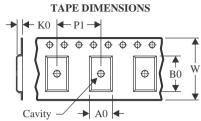
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Dev | vice | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------|---------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LS | 257BDR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS2 | 257BNSR | so | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LS | 258BDR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |

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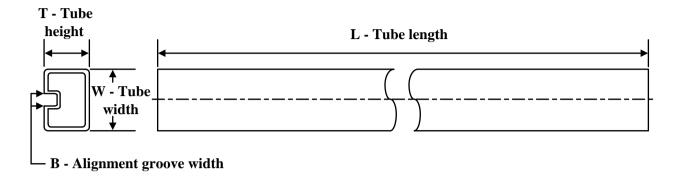
*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS257BDR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |
| SN74LS257BNSR | SO | NS | 16 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74LS258BDR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |



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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 7603701FA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| JM38510/07906BFA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| JM38510/30906B2A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| JM38510/30906BFA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| M38510/07906BFA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| M38510/30906B2A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| M38510/30906BFA | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |
| SN74LS257BD | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS257BN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS257BN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS258BD | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS258BN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS258BN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74S257N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74S257N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54LS257BFK | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| SNJ54LS257BW | W | CFP | 16 | 1 | 506.98 | 26.16 | 6220 | NA |

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE

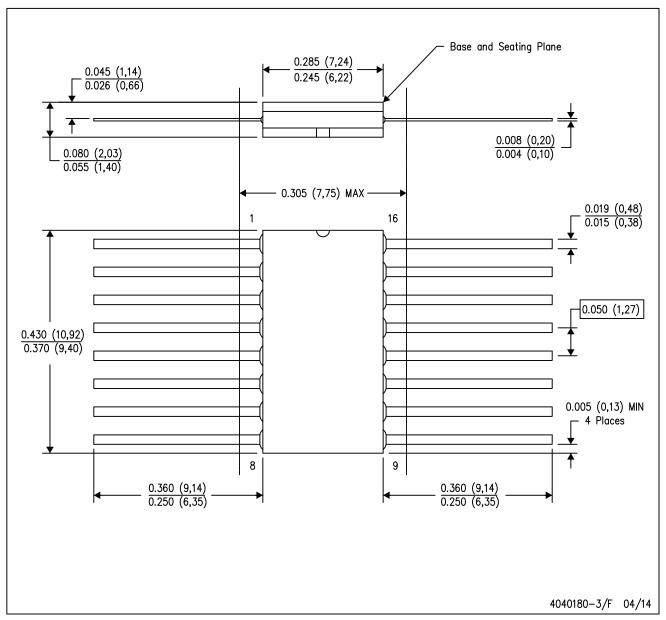


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

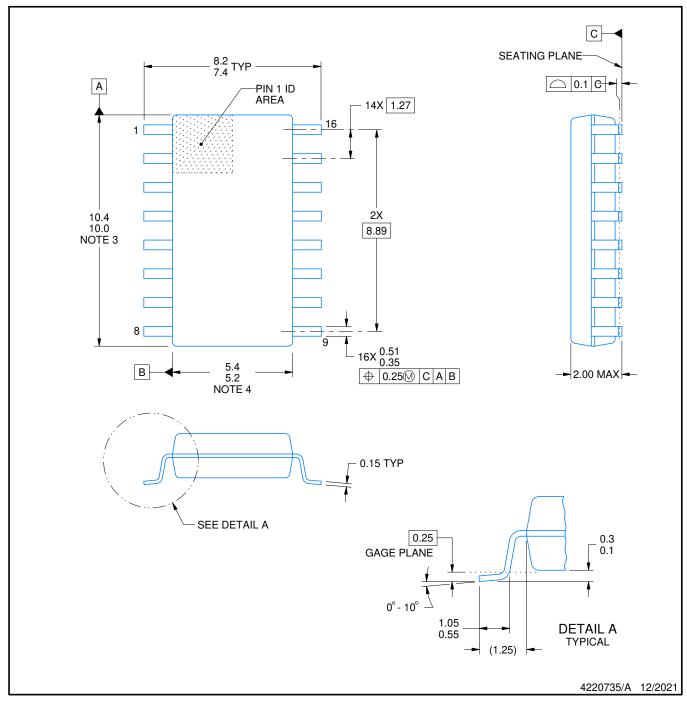


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOP



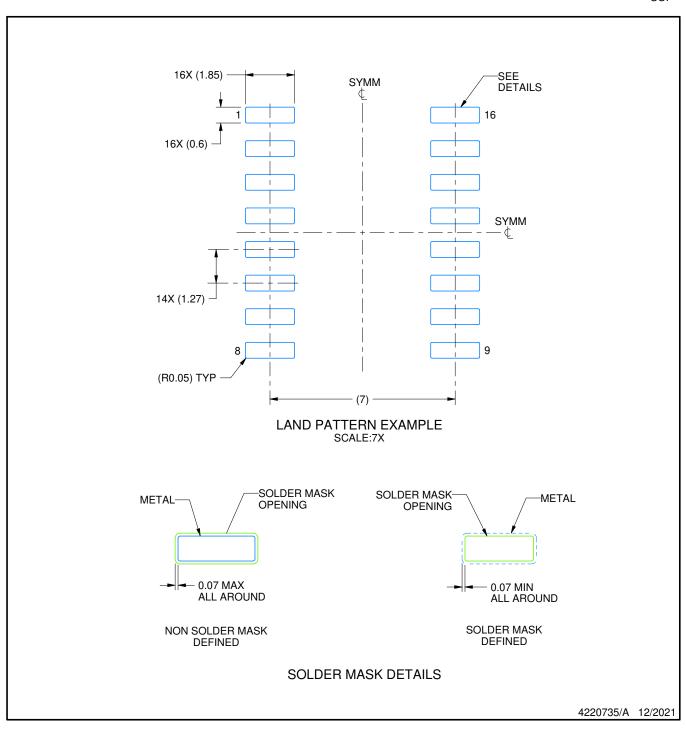
- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF



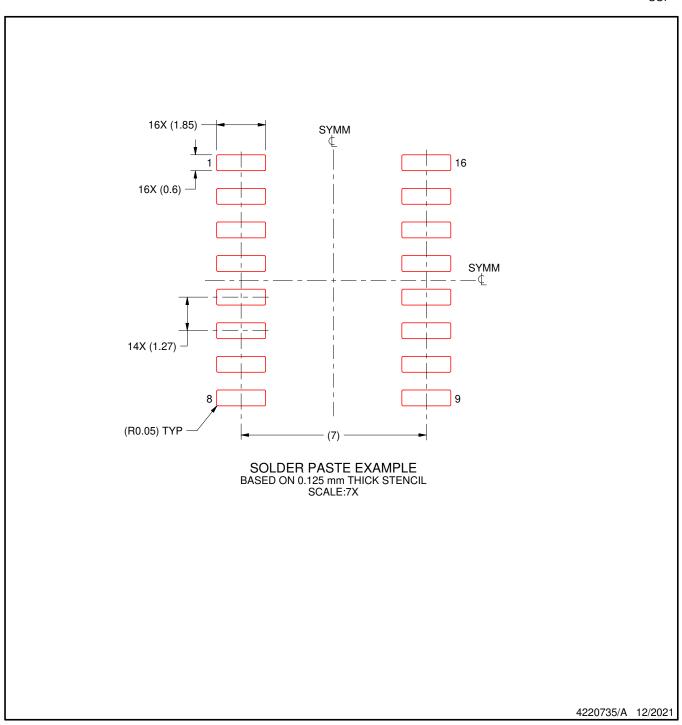
NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOP



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



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